

High Efficient Surface Mount Rectifiers
Reverse Voltage 50 to 1000 Volts Forward Current 1.0 Ampere

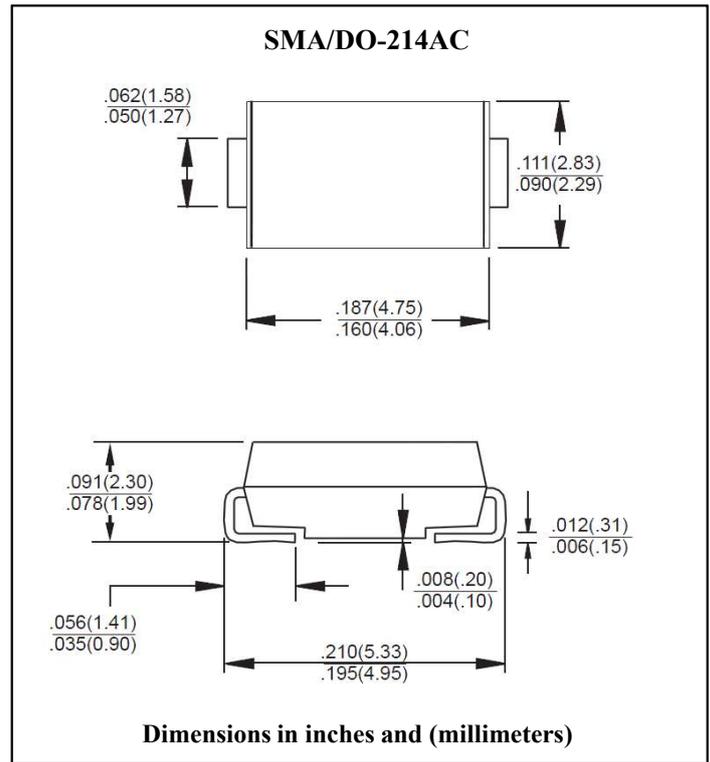
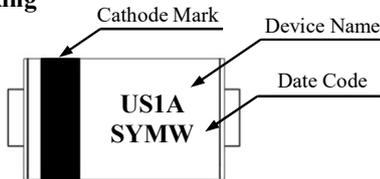
Features

- For surface mounted application
- Glass passivated junction chip
- Low forward voltage drop
- Low profile package
- Built-in stain relief, ideal for automatic placement
- Fast switching for high efficiency
- Plastic material used carries underwriters laboratory classification 94V-O
- High temperature soldering : 260°C /10 seconds at terminals

Mechanical Data

- Case : Molded plastic
- Terminals : Solder plated
- Polarity : Indicated by cathode band
- Packaging : 12mm tape per EIA STD RS-481
- Weight : 0.064gram

Marking



Maximum Ratings & Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified
Single phase half wave 60 Hz, resistive or inductive load
For capacitive load, derate current by 20%

Parameter	Symbol	US1A	US1B	US1D	US1G	US1J	US1K	US1M	Unit	Remark
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V	
Maximum Average Forward Rectified Current See Fig.1	$I_F(AV)$	1.0							A	
Peak Forward Surge Current 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	30							A	
Maximum Instantaneous Forward Voltage @ 1.0A	V_F	1.0		1.3		1.7		V		
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	5.0							uA	Ta=25°C
		150							uA	Ta=125°C
Maximum Reverse Recovery Time	t_{rr}	50				75		ns	Note 1	
Typical Junction Capacitance	C_J	15				10		pF	Note 2	
Typical Thermal Resistance	$R_{th(j-a)}$	75							°C /W	Note 3
	$R_{th(j-l)}$	27								
Operation Junction Temperature Range	T_J	-55 to +150							°C	
Storage Temperature Range	T_{STG}	-55 to +150							°C	

Note 1. Reverse Recovery Time Test Conditions : $I_F=0.5A$, $I_R=1.0A$, $I_{RR}=0.25A$

Note 2. Measured at 1MHz and Applied Reverse Voltage of 4.0Volts D.C.

Note 3. Mounted on P.C.B with 0.2"×0.2" (5mm×5mm) Copper Pad Areas

Ratings and Characteristics Curves (Ta=25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

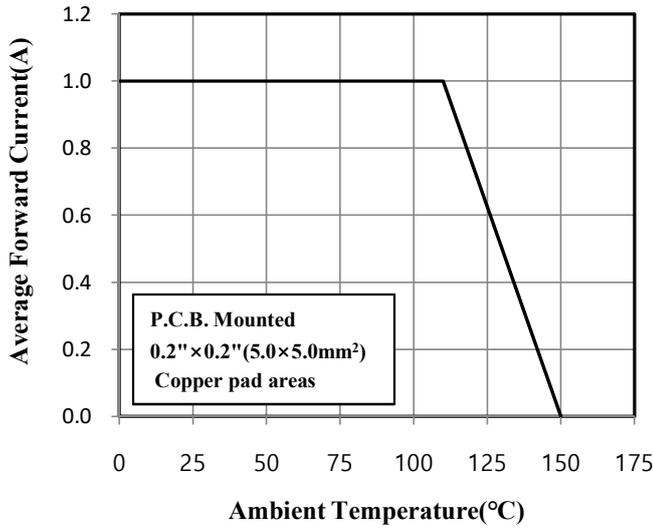


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

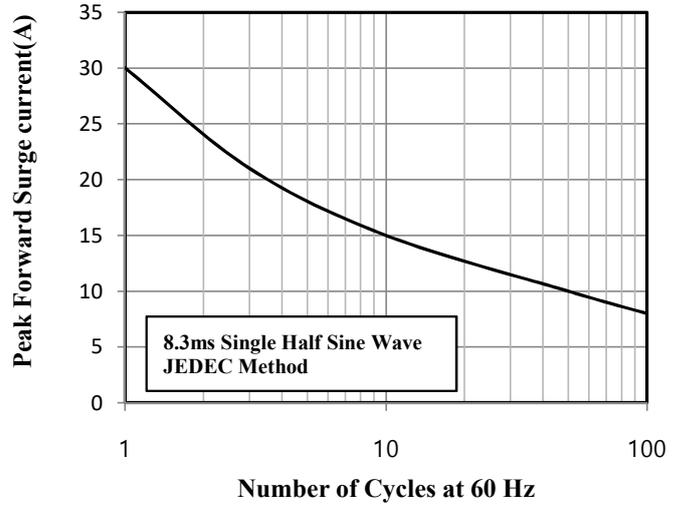


Fig.3 Typical Instantaneous Forward Characteristics

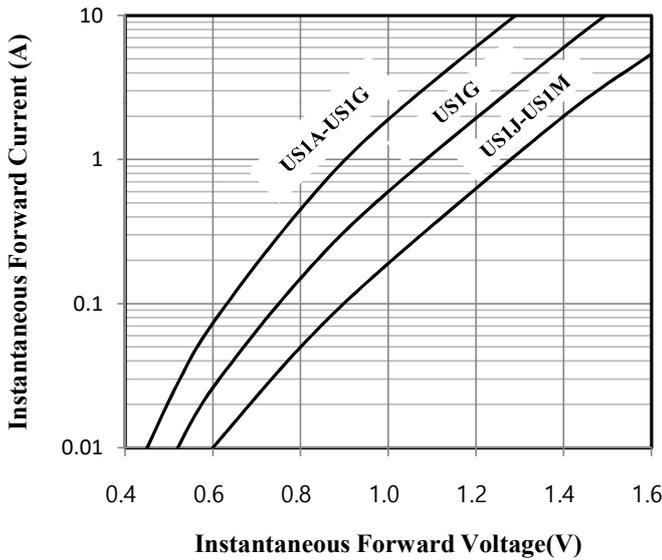


Fig.4 Typical Junction Capacitance

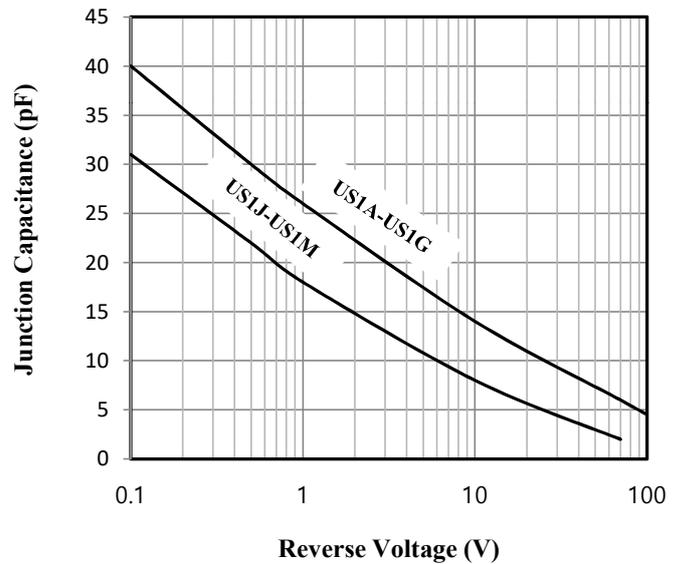


Fig.5 Typical Reverse Characteristics

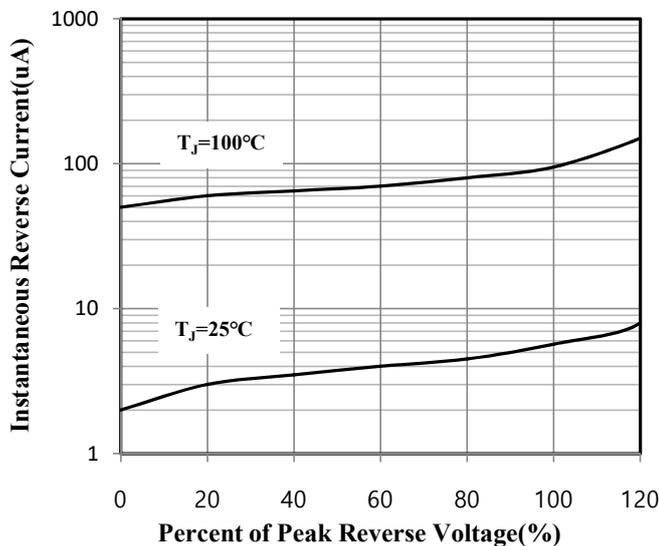


Fig. 6 Reverse Recovery Time Characteristic and Test Circuit Diagram

